



AWT6252

IMT/WCDMA 3.4V/27.5dBm
Linear Power Amplifier Module
PRELIMINARY DATA SHEET - Rev 1.3

FEATURES

- InGaP HBT Technology
- High Efficiency: 39%
- Low Quiescent Current: 50 mA
- Low Leakage Current in Shutdown Mode: $<1 \mu\text{A}$
- $V_{\text{REF}} = +2.85 \text{ V}$ (+2.75 V min over temp)
- Optimized for a 50Ω System
- Low Profile Miniature Surface Mount Package:
1.56mm Max

APPLICATIONS

- Dual Mode 3GPP Wireless Handsets



M7 Package
10 Pin 4 x 4 x 1.5 mm
Surface Mount Module

PRODUCT DESCRIPTION

The AWT6252 meets the increasing demands for higher output power in 3GPP 1XRTT handsets. The PA module is optimized for $V_{\text{REF}} = +2.85 \text{ V}$, a requirement for compatibility with the Qualcomm® 6250 chipset. The device is manufactured on an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness.

Selectable bias modes that optimize efficiency for different output power levels, and a shutdown mode with low leakage current, increase handset talk and standby time. The self-contained $4 \times 4 \times 1.5 \text{ mm}$ surface mount package incorporates matching networks optimized for output power, efficiency, and linearity in a 50Ω system.

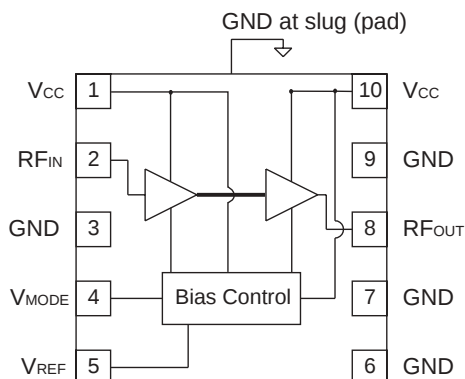


Figure 1: Block Diagram

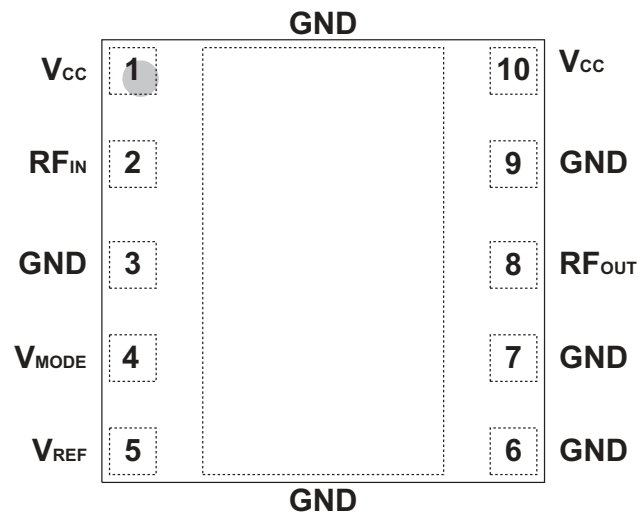


Figure 2: Pinout (X-ray Top View)

Table 1: Pin Description

PIN	NAME	DESCRIPTION
1	V _{CC}	Supply Voltage
2	RF _{IN}	RF Input
3	GND	Ground
4	V _{MODE}	Mode Control Voltage
5	V _{REF}	Reference Voltage
6	GND	Ground
7	GND	Ground
8	RF _{OUT}	RF Output
9	GND	Ground
10	V _{CC}	Supply Voltage

ELECTRICAL CHARACTERISTICS

Table 2: Absolute Minimum and Maximum Ratings

PARAMETER	MIN	MAX	UNIT
Supply Voltage (V_{CC})	0	+5	V
Mode Control Voltage (V_{MODE})	0	+3.5	V
Reference Voltage (V_{REF})	0	+3.5	V
RF Input Power (P_{IN})	-	+10	dBm
Storage Temperature (T_{STG})	-40	+150	°C

Stresses in excess of the absolute ratings may cause permanent damage. Functional operation is not implied under these conditions. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Table 3: Operating Ranges

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Operating Frequency (f)	1920	-	1980	MHz	
Supply Voltage (V_{CC})	+3.2	+3.4	+4.2	V	
Reference Voltage (V_{REF})	+2.75 0	+2.85 -	+2.95 +0.5	V	PA "on" PA "shut down"
Mode Control Voltage (V_{MODE})	+2.5 0	+2.8 -	+3.1 +0.5	V	Low Bias Mode High Bias Mode
RF Output Power (P_{OUT})	+27.0 ⁽¹⁾	+27.5	-	dBm	
Case Temperature (T_C)	-10	-	+90	°C	

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

Notes:

(1) For operation at $T_C = +90^\circ\text{C}$ and $V_{CC} = +3.2\text{ V}$, P_{OUT} is derated by 0.5 dB.

Table 4: Electrical Specifications
(T_C = +25 °C, V_{CC} = +3.4 V, V_{REF} = +2.85 V, 50 Ω system)

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Gain	24.5 22 17	26.5 24.5 20.5	29 27 24	dB	P _{OUT} = +27.5 dBm, V _{MODE} = 0 V P _{OUT} = +16 dBm, V _{MODE} = +2.85 V P _{OUT} = +16 dBm, V _{CC} = 1.5 V, V _{MODE} = +2.85 V
ACLR1 at 5 MHz offset ⁽¹⁾	- - -	-43 -41 -46	-38 -38 -38	dBc	P _{OUT} = +27.5 dBm, V _{MODE} = 0 V P _{OUT} = +16 dBm, V _{MODE} = +2.85 V P _{OUT} = +16 dBm, V _{CC} = 1.5 V, V _{MODE} = +2.85 V
ACLR2 at 10 MHz offset	- - -	-60 -62 -60	-50 -50 -48	dBc	P _{OUT} = +27.5 dBm, V _{MODE} = 0 V P _{OUT} = +16 dBm, V _{MODE} = +2.85 V P _{OUT} = +16 dBm, V _{CC} = 1.5 V, V _{MODE} = +2.85 V
Power-Added Efficiency ⁽¹⁾	37 8.5 19	39 9.5 21.5	- - -	%	P _{OUT} = +27.5 dBm, V _{MODE} = 0 V P _{OUT} = +16 dBm, V _{MODE} = +2.85 V P _{OUT} = +16 dBm, V _{CC} = 1.5 V, V _{MODE} = +2.85 V
Quiescent Current (I _{cq})	-	53	65	mA	V _{MODE} = +2.85 V
Reference Current	-	3.8	5	mA	through V _{REF} pin
Mode Control Current	-	0.3	0.5	mA	through V _{MODE} pin, V _{MODE} = +2.85 V
Leakage Current	-	<1	5	μA	V _{CC} = +4.2 V, V _{REF} = 0 V, V _{MODE} = 0 V
Noise in Receive Band	-	-139	-137	dBm/Hz	2110 MHz to 2170 MHz
Harmonics 2fo 3fo, 4fo	- - -	-45 -50	-30 -30	dBc	
Input Impedance	-	-	2:1	VSWR	
Spurious Output Level (all spurious outputs)	-	-	-70	dBc	P _{OUT} ≤ +27.5 dBm In-band load VSWR < 5:1 Out-of-band load VSWR < 10:1 Applies over all voltage and temperature operating ranges
Load mismatch stress with no permanent degradation or failure	8:1	-	-	VSWR	V _{CC} = +5.0 V, P _{IN} = +5 dBm Applies over full operating temperature range

Notes:

(1) ACLR and Efficiency measured at 1950 MHz.

APPLICATION INFORMATION

To ensure proper performance, refer to all related Application Notes on the ANADIGICS web site: <http://www.anadigics.com>

Shutdown Mode

The power amplifier may be placed in a shutdown mode by applying logic low levels (see Operating Ranges table) to both the V_{REF} and V_{MODE} voltages.

Bias Modes

The power amplifier may be placed in either a Low Bias mode or a High Bias mode by applying the appropriate logic level (see Operating Ranges table) to the V_{MODE} voltage. The Bias Control table lists the recommended modes of operation for various applications.

Table 5: Bias Control

APPLICATION	P_{OUT} LEVELS	BIAS MODE	V_{REF}	V_{MODE}	V_{CC}
CDMA - low power	$\leq +16\text{dBm}$	Low	+2.85 V	+2.85 V	$\geq +1.5$
CDMA - high power	$> +16\text{ dBm}$	High	+2.85 V	0 V	+3.4
Shutdown	-	Shutdown	0 V	0 V	-

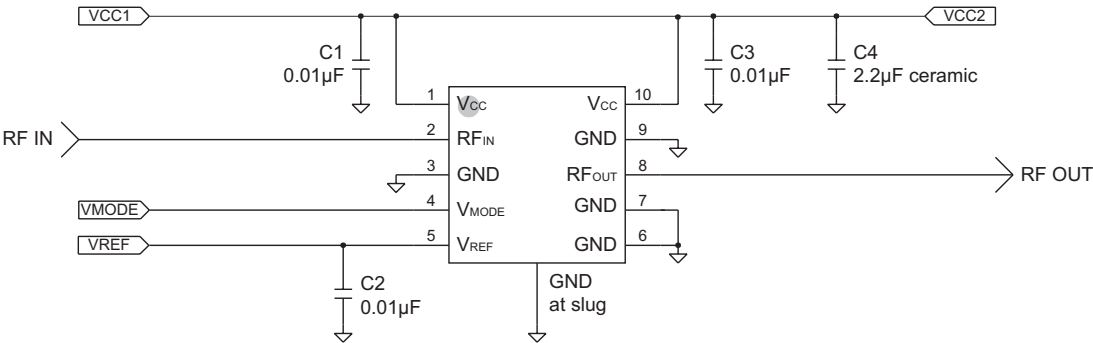
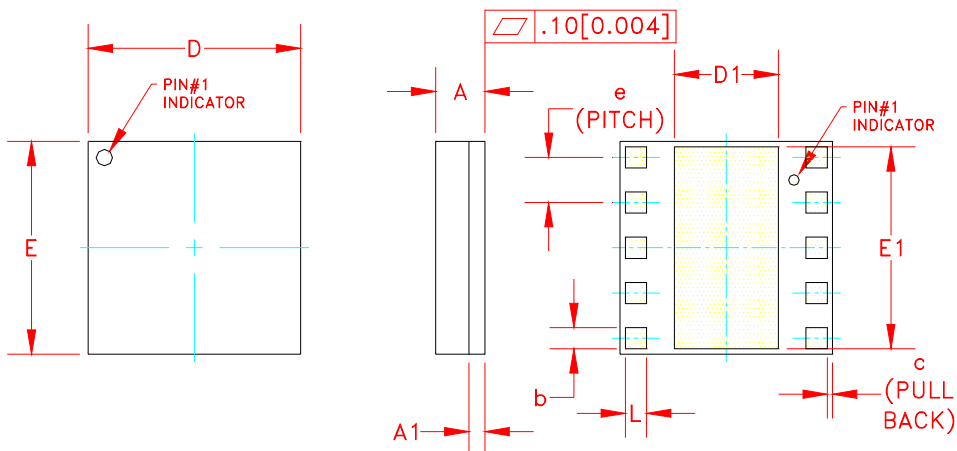


Figure 3: Application Circuit Schematic

PACKAGE OUTLINE

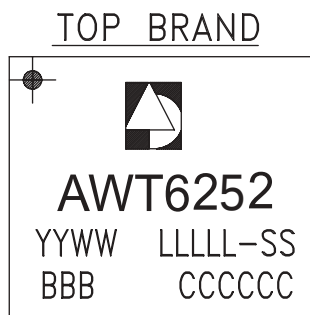


	MILLIMETERS			INCHES			NOTE
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	1.26	1.41	1.56	0.049	0.055	0.061	—
A1	—	0.30	—	—	0.012	—	—
b	0.35	—	0.60	0.013	—	0.024	3
c	—	0.10	—	—	0.004	—	—
D	3.88	4.00	4.12	0.152	0.157	0.162	—
D1	1.90	—	2.20	0.075	—	0.086	—
E	3.88	4.00	4.12	0.152	0.157	0.162	—
E1	3.75	—	3.85	0.148	—	0.152	—
e	—	0.85	—	—	0.033	—	3
L	0.35	—	0.60	0.013	—	0.024	3

NOTES:

1. CONTROLLING DIMENSIONS: MILLIMETERS
2. UNLESS SPECIFIED TOLERANCE=±0.076[0.003].
3. PADS (INCLUDING CENTER) SHOWN UNIFORM SIZE FOR REFERENCE ONLY. ACTUAL PAD SIZE AND LOCATION WILL VARY WITHIN MIN. AND MAX. DIMENSIONS ACCORDING TO SPECIFIC LAMINATE DESIGN.

Figure 4: M7 Package Outline - 10 Pin 4 x 4 x 1.5 mm Surface Mount Module

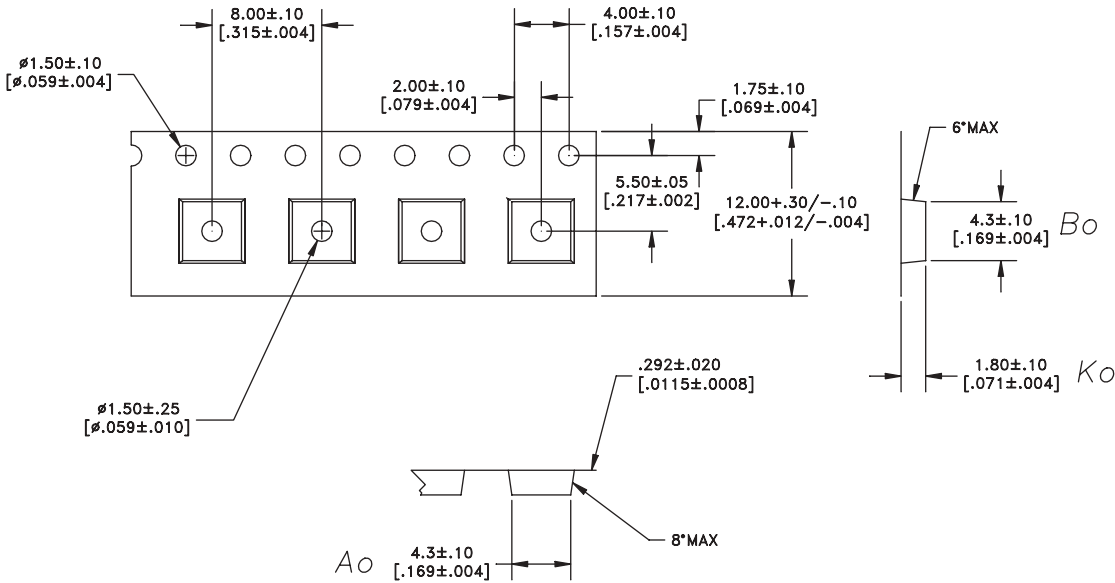


NOTES:

1. ANADIGICS LOGO SIZE: $X=0.040\pm0.010$ $Y=0.048\pm0.010$
2. PART # AWT6252
3. YEAR AND WORK WEEK: YYWW: YY = YEAR, WW = WORK WEEK
4. LOT - WAFER I.D.: LLLLL - SS = WAFER/LOT I.D.
5. PIN 1 INDICATOR: MOLD NOTCH -or- INK DOT
6. BOM # BBB
7. COUNTRY CODE: CCCCC
8. TYPE : ELITE
SIZE : AS LARGE AS POSSIBLE
LASER MARKED

Figure 5: Branding Specification

COMPONENT PACKAGING



DIMENSIONS ARE IN MILLIMETERS [INCHES]
STANDARD TOLERANCES

Figure 6: Tape & Reel Packaging

Table 6: Tape & Reel Dimensions

PACKAGE TYPE	TAPE WIDTH	POCKET PITCH	REEL CAPACITY	MAX REEL DIA
4 X 4 x 1.5 mm	12mm	8mm	2500	13"

ORDERING INFORMATION

ORDER NUMBER	TEMPERATURE RANGE	PACKAGE DESCRIPTION	COMPONENT PACKAGING
AWT6252M7P8	-10 °C to +90 °C	10 Pin 4 x 4 x 1.5 mm Surface Mount Module	Tape and Reel, 2500 pieces per Reel

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